

FORM PTO-1449 (Modified) LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)	ATTY. DOCKET NO. ROC920010024US2	SERIAL NO. Unknown 10/672,752
APPLICANT: Mark K. Hoffmeyer		
FILING DATE: 25 September 2003		GROUP: Unknown 2841

**REFERENCE DESIGNATION
U.S. PATENT DOCUMENTS**

EXAMINER INITIALS		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE (IF APPRO.)
TD	AA	6 4 4 2 0 4 5	27 August 2002	Goodwin et al.	361	816	
	AB	6 0 4 2 4 1 2	28 March 2000	Murr, Keith	439	331	
	AC	5 9 6 7 7 9 7	19 October 1999	Maldonado, Ralph	439	66	
	AD	5 8 2 0 3 8 9	13 October 1998	Hashiguchi, Osamu	439	66	
	AE	5 6 5 3 6 0 0	05 August 1997	Ollivier, Jean-Francois	439	73	
V	AF	5 1 9 9 8 8 9	06 April 1993	McDevitt, Jr., John E.	439	66	
TD	AG						
	AH						
	AI						
	AJ						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSLATIO N YES NO
	AK						
	AL						
	AM						

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

TD	AN	U.S. Patent Application Serial No. 09/852,998 filed 10 May 2001 entitled LAND GRID ARRAY (LGA) PAD REPAIR STRUCTURE AND METHOD by Ma et al.
TD	AO	U.S. Patent Application Serial No. unknown filed 22 August 2001 entitled LGA CONNECTOR WITH INTEGRATED GASKET by Hoffmeyer, IBM Docket No. ROC920000212US1.
TD	AP	Tummala and Rymaszewski (eds.) <u>Microelectronics Packaging Handbook</u> , Van Nostrand Reinhold, New York, 1989, Chapter 12, pp. 853-919.

EXAMINER <u>Tuan Dinh</u>	DATE CONSIDERED <u>2-23-06</u>
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.